

SEA & LAND ELECTRONIC CORP.

www.sealand-pptc.com

ALPHA-TOP TECHNOLOGY CORP.

www.alpha-top.cn

APPROVAL SHEET

MC	ODEL NO.:	SMD200L-36V	
CU	JSTOMER:		
CU	JSTOMER'S APPF	ROVAL:	
AU	JTHORIZED SIGN	ATURE/STAMP:	
DA	ATE		

MANUFACTURER:

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Submitted by: Chen Approved by: YC Lin DATE: 10-Apr-24

SEA & LAND ELECTRONIC CORP.



■ Surface Mount Devices

■ Lead free device ■ Size 7.5*5.5 mm 0.29*0.20 inch

■ Surface Mount packaging for automated assembly

Applications

Almost anywhere there is a low voltage power supply, up to 60V and a load to be protected, including:

■ Computer mother board, Modem. ■ Telecommunication equipments.

Alpha-Top (Sea & Land Alliance)

Performance Specification

						Maxi	imum	Pools	Resistance		
Model	V_{max}	I _{max}	I _{hold}	I_{trip}	P_d	Time '	To Trip	Resis	stance	Agency	Approval
Wodei			@25°C	@25°C	Тур.	Current	Time	Ri _{min}	R1 _{max}	UL	TUV
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	UL	100
SMD200L-36V	36	100	2.00	4.00	1.5	8.0	4.5	0.020	0.120		

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

= Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1max = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

Environmental Specifications					
Test	Conditions				
Passive aging	+85°C, 1000 hrs.				
Humidity aging	+85°C, 85% R.H., 168 hours				
Thermal shock	+85°C to -40°C, 20 times				
Resistance to solvent	MIL-STD-202, Method 215				
Vibration	MIL-STD-202, Method 201				
Ambient operating conditions : - 40 °C to +85 °C					
Maximum surface temperature of the device in the tripped state is 125 °C					
In case of special use, please contact our engineer					

Agency Approvals :

Regulation/Standard:

2015/863/EU

EN14582

I Versus Temperature

Model Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})									
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD200L-36V	3.02	2.68	2.34	2.00	1.66	1.50	1.32	1.16	0.90



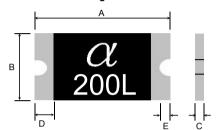


Alpha-Top (Sea & Land Alliance)

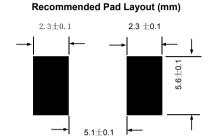
Construction And Dimension (Unit:mm)

Model		Α		В		С		E
Wodel	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
SMD200L-36V	6.73	7.98	4.80	5.44	0.90	1.80	0.30	0.30

Dimensions & Marking



 α = Trademark 200 = Hold current



Termination Pad Characteristics

Terminal pad materials :

Tin-plated Nickel-Copper

Terminal pad solderability:

Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

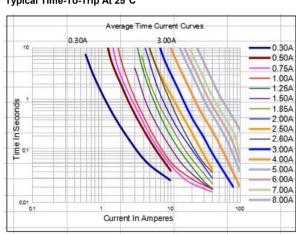
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



WARNING:

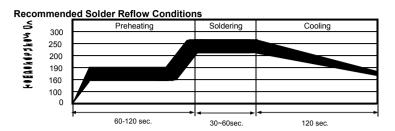
- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated. Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

- Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

 Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

 Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
- Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices





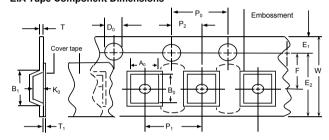
- Recommended reflow methods : IR, vapor phase oven, hot air oven.
- · Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.

Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

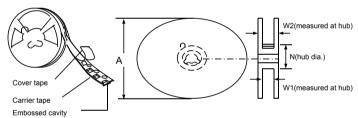
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-2
W	16.0 ± 0.3
P_0	4.0 ± 0.10
P ₁	8.0 ± 0.10
P ₂	2.0 ± 0.05
A_0	5.70 ± 0.10
B ₀	8.00 ± 0.10
B₁max.	12.1
D_0	1.5 + 0.1, -0
F	7.5 ± 0.05
E ₁	1.75 ± 0.10
E ₂ min.	14.25
Tmax.	0.6
T₁max.	0.1
K ₀	0.80 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W_1	16.4 + 2.0, -0.0
W₂max.	22.4

EIA Tape Component Dimensions



EIA Reel Dimensions



- Storage And Handling
 Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information Packaging

SMD	200L-36V	Tape & Reel Quantity
Product name	Hold	
Size 7555 mm /2920 inch	Current	1.500 pcs/reel
SMD : surface mount device	2 00A	

Tape & reel packaging per EIA481-1

Labeling Information

